



US00D552338S

(12) **United States Design Patent**  
**Choi et al.**

(10) **Patent No.:** **US D552,338 S**

(45) **Date of Patent:** **\*\* Oct. 9, 2007**

(54) **FOOTWEAR**

(75) Inventors: **Sandra Choi**, London (GB); **Daniel Lawler**, London (GB)

(73) Assignee: **J. Choo Limited**, London (GB)

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/286,585**

(22) Filed: **May 10, 2007**

**Related U.S. Application Data**

(62) Division of application No. 29/263,367, filed on Jul. 20, 2006.

(30) **Foreign Application Priority Data**

Jan. 20, 2006 (EM) ..... 000469945-027

(51) **LOC (8) Cl.** ..... **02-99**

(52) **U.S. Cl.** ..... **D2/971**

(58) **Field of Classification Search** ..... D2/925-942,  
D2/971

See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

D75,276 S *	5/1928	Miller	.....	D2/929
D79,400 S *	9/1929	Morali	.....	D2/930
D91,534 S *	2/1934	Morali	.....	D2/930
D91,535 S *	2/1934	Morali	.....	D2/932

D92,620 S *	6/1934	Morali	.....	D2/932
D92,935 S *	7/1934	Stern	.....	D2/930
D94,639 S *	2/1935	Stritter	.....	D2/935
D101,274 S *	9/1936	Gerton	.....	D2/930
D108,481 S *	2/1938	Parker	.....	D2/930
D110,446 S *	7/1938	Sholtz	.....	D2/931
D131,170 S *	1/1942	Wolock	.....	D2/932
D525,415 S *	7/2006	Kelsey	.....	D2/930

\* cited by examiner

*Primary Examiner*—Dominic Simone

(74) *Attorney, Agent, or Firm*—Fross Zelnick Lehrman & Zissu, P.C.; Lawrence E. Apolzon, Esq.

(57) **CLAIM**

The ornamental design for footwear, as shown and described.

**DESCRIPTION**

FIG. 1 is a front perspective view of a shoe showing my footwear design;

FIG. 2 is a left side view of the footwear shown in FIG. 1;

FIG. 3 is a right side view of the footwear shown in FIG. 1;

FIG. 4 is a front view of the footwear shown in FIG. 1; and,

FIG. 5 is a rear view of the footwear shown in FIG. 1.

The broken line showing of the heel, heel cap, sole, buckle, and buckle holes, is for illustrative purposes only and forms no part of the claimed design.

**1 Claim, 5 Drawing Sheets**





FIG. 1

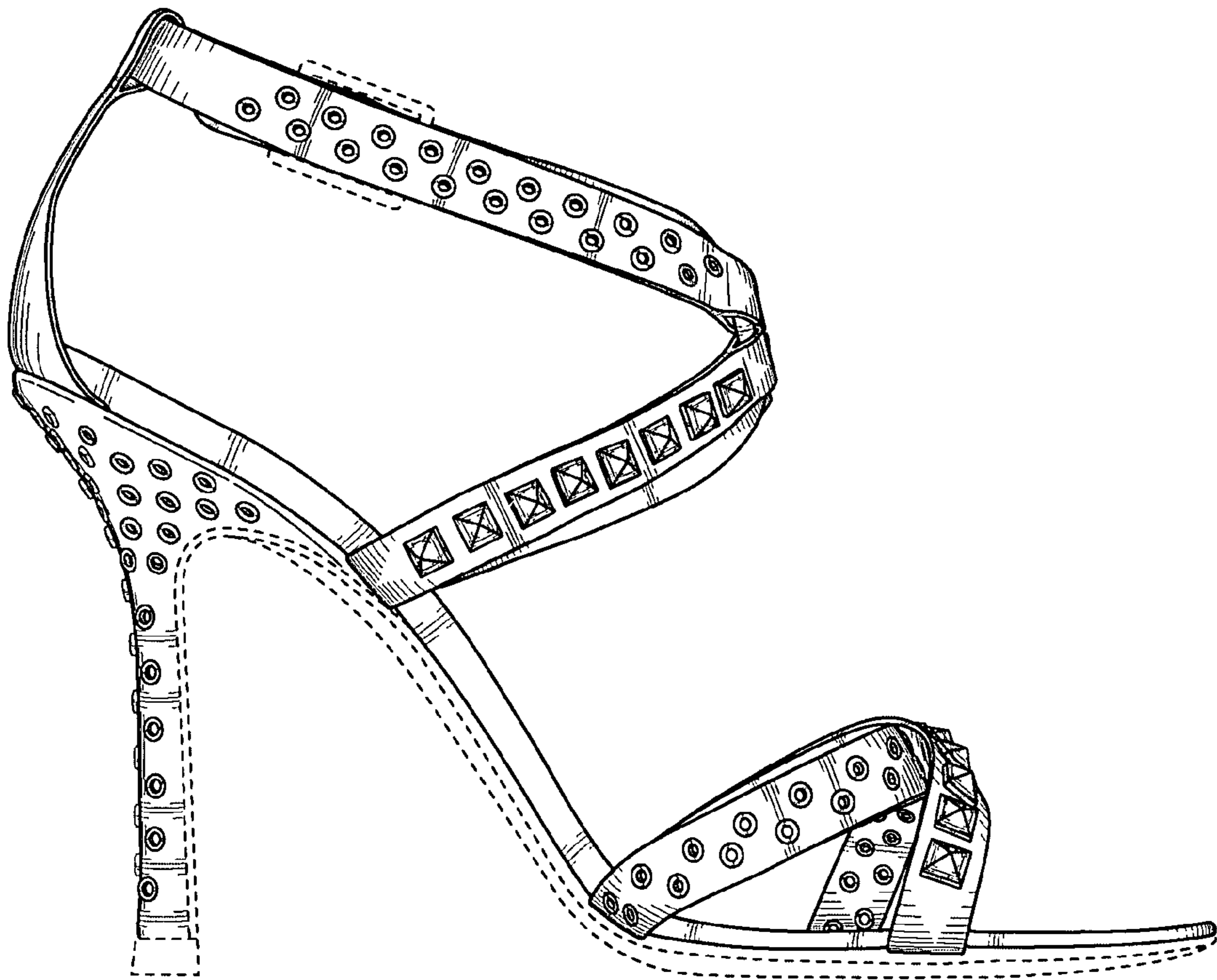


FIG. 2

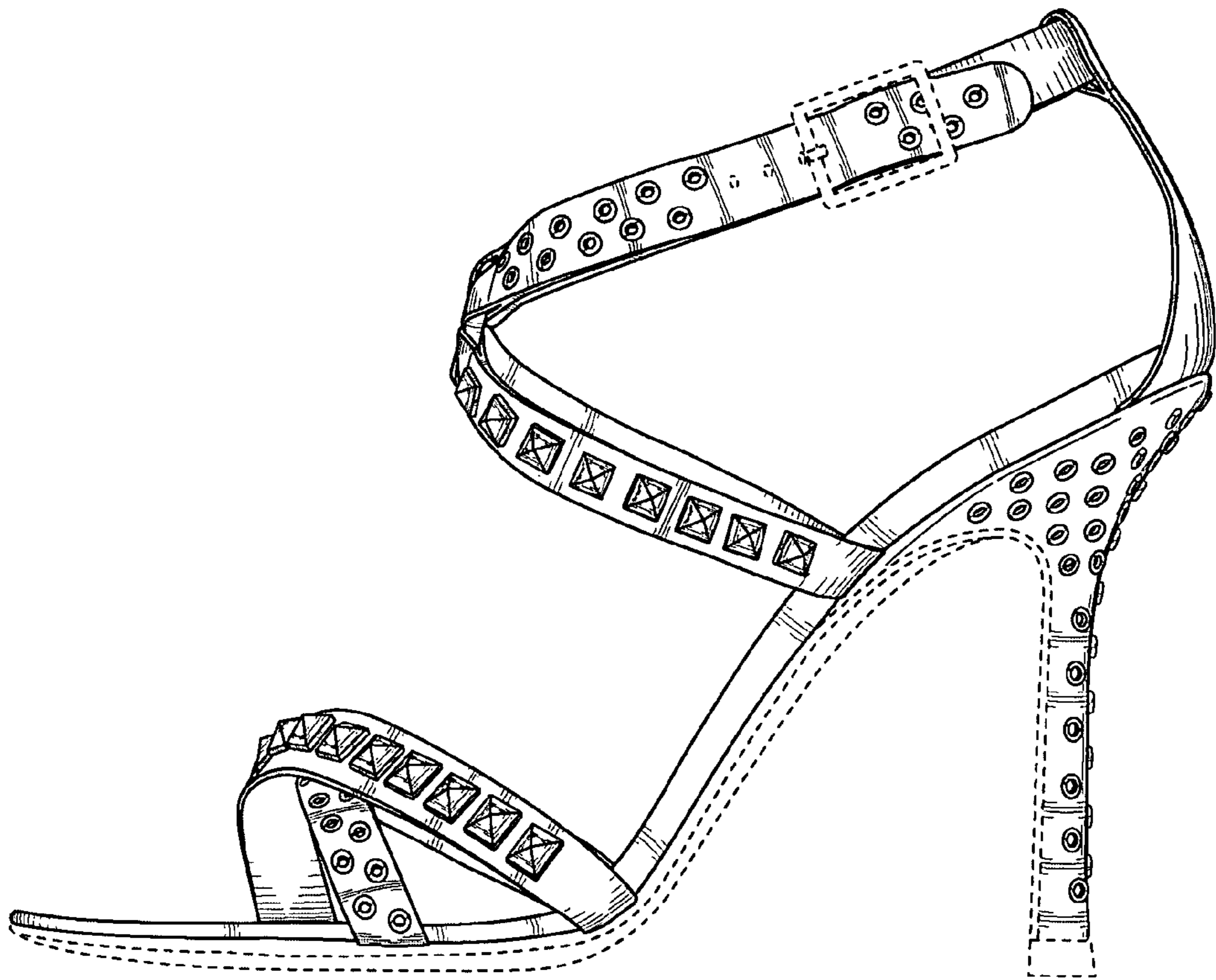


FIG. 3

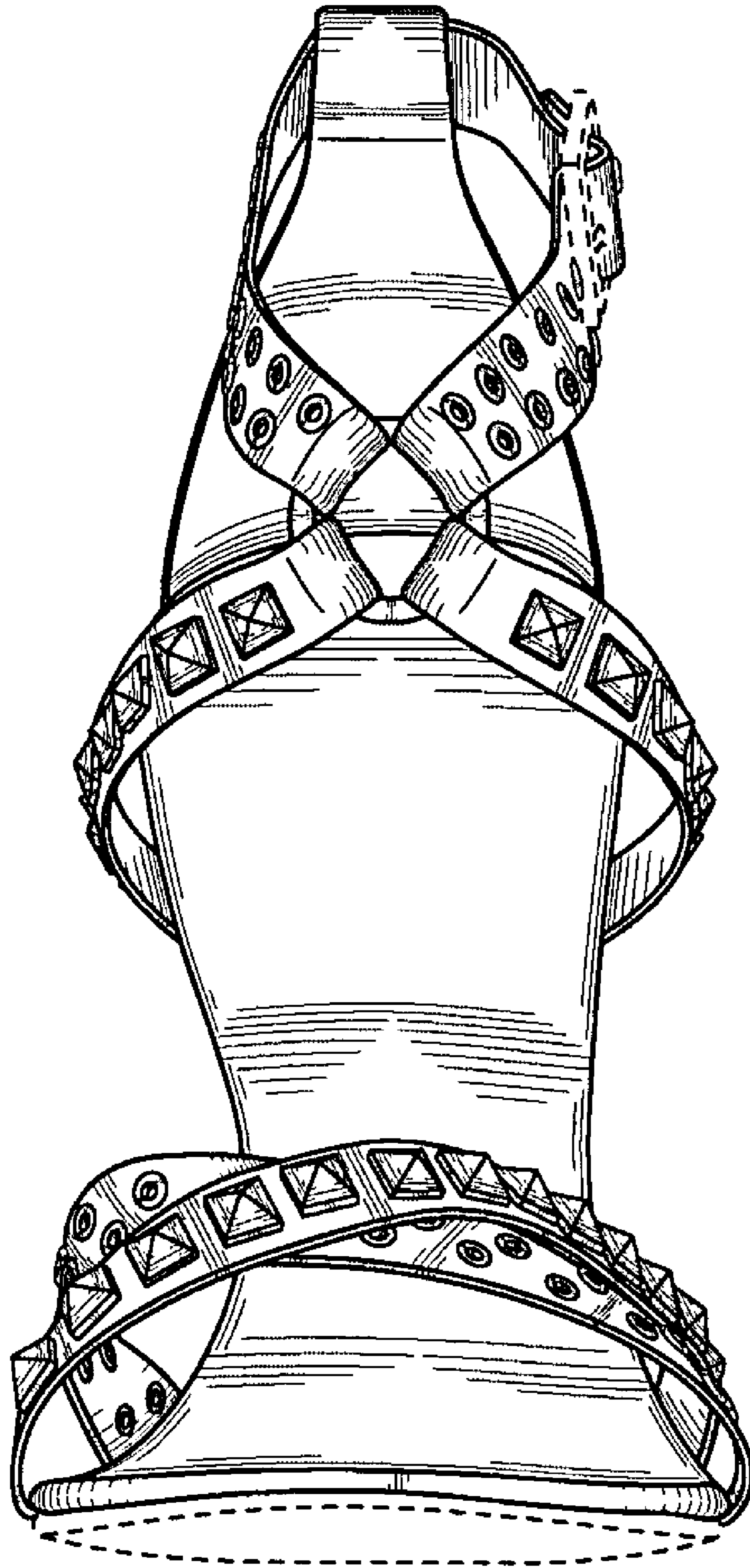


FIG. 4

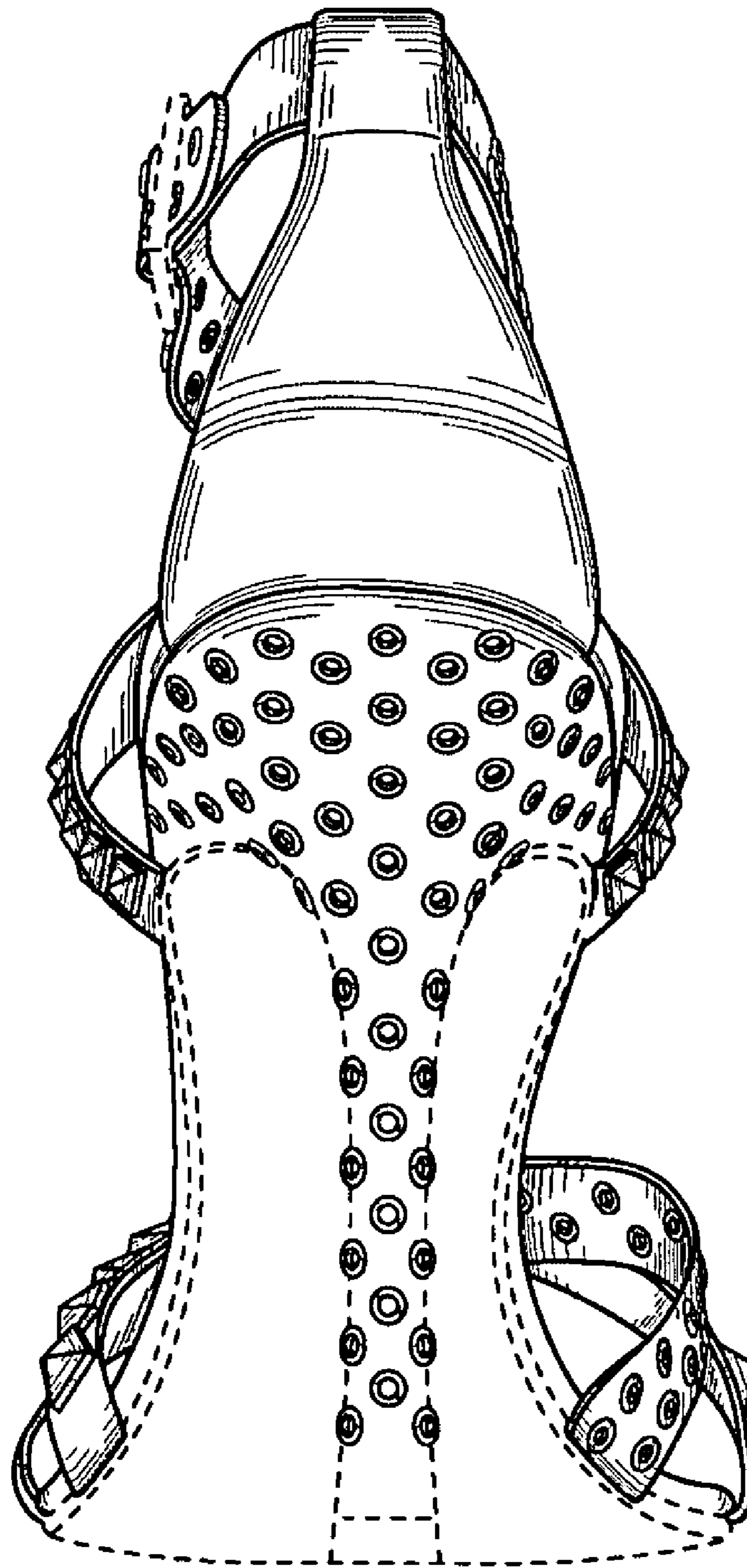


FIG. 5